

# 低功率 J-FET 输入运算放大器

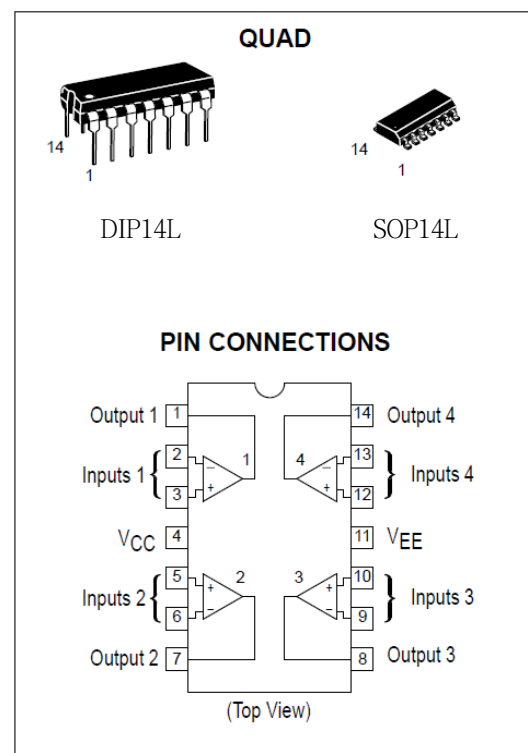
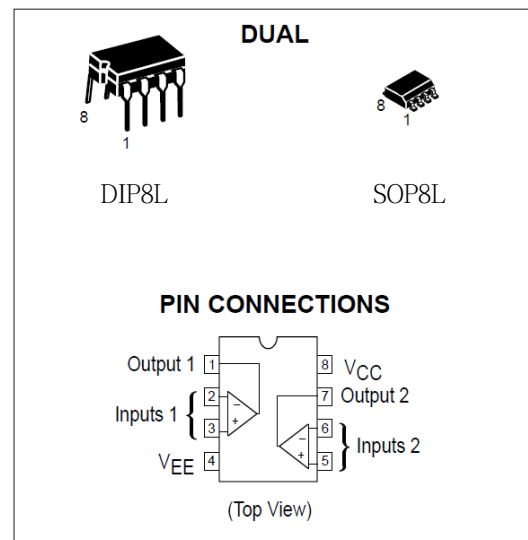
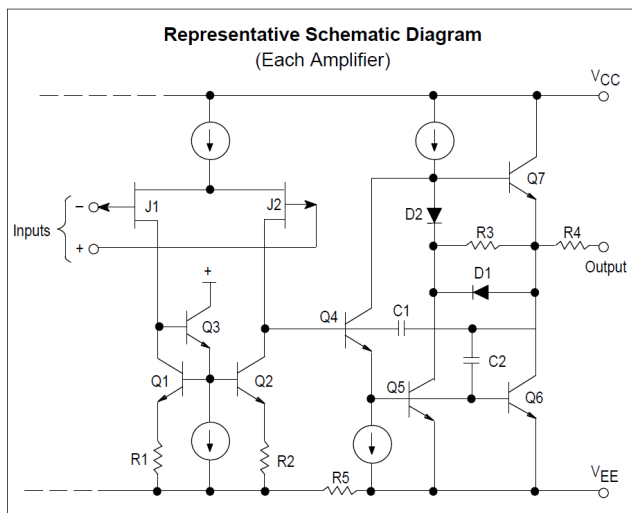
## 概述

这类 J-FET 输入运算放大器专为低功耗应用而设计，它们的特点是高输入阻抗，低输入偏置电流和低输入失调电流。

先进的设计技术保证了更高的转换速率，增益带宽积和输出摆幅。商业和车辆设备可用塑料双列直插和 SOP 封装。

## 主要特点

- 低电源电流：200uA/Amplifier
- 低输入偏置电流：5.0pA
- 高增益带宽：2.0MHz
- 高转换率：6.0V/uS
- 高输入阻抗： $10^{12}\Omega$
- 大输出电压摆幅： $\pm 14V$
- 输出短路保护



## 产品订购信息

| 产品名称       | 封装     | 打印名称  | 包装 | 包装数量     |
|------------|--------|-------|----|----------|
| TL062N     | DIP8L  | TL062 | 管装 | 2000 只/盒 |
| TL062CM/TR | SOP8L  | TL062 | 编带 | 2500 只/盘 |
| TL062IM/TR | SOP8L  | TL062 | 编带 | 2500 只/盘 |
| TL064N     | DIP14L | TL064 | 管装 | 1000 只/盒 |
| TL064CM/TR | SOP14L | TL064 | 编带 | 2500 只/盘 |
| TL064IM/TR | SOP14L | TL064 | 编带 | 2500 只/盘 |

## 最大额定值

| 类别                    | 符号               | 值           | 单位  |
|-----------------------|------------------|-------------|-----|
| 电源 (从 VCC 到 VEE)      | VS               | +36         | V   |
| 输入差分电压范围 (注 1)        | V <sub>IDR</sub> | ± 30        | V   |
| 输入电压范围 (注 1 和注 2)     | V <sub>IR</sub>  | ± 15        | V   |
| 输出短路持续时间 (注 3)        | tsc              | 待定          | sec |
| 工作结温 TL062C<br>TL062I | T <sub>J</sub>   | 0 to 70     | °C  |
|                       |                  | -40 to +85  | °C  |
| 存贮温度范围                | T <sub>stg</sub> | -60 to +150 | °C  |

- 注：1. 差分电压相对于反相输入端子位于同相输入端。  
 2. 输入电压的大小绝不能超过供电电压 15 伏的幅度，以较小者为准。  
 3. 必须考虑功耗，以确保不超过最大结温。

## 电特性 (V<sub>CC</sub>=20V, T<sub>amp</sub>=25°C 特殊情况另外说明)

| 参数                                                  | 符号                   | TL062/TL064 |              |           | 单位       |
|-----------------------------------------------------|----------------------|-------------|--------------|-----------|----------|
|                                                     |                      | Min         | Typ          | Max       |          |
| 输入失调电压(RS=50Ω, VO=0V)<br>TA=25°C<br>TA=0°C to +70°C | V <sub>IO</sub>      | —           | 3.0          | 15<br>20  | mV       |
| 偏移电压的平均温度系数<br>(RS=50Ω, VO=0V)                      | ΔV <sub>IO</sub> /ΔT | —           | 10           | —         | uV/°C    |
| 输入失调电流(VCM=0V, VO=0V)<br>TA=25°C<br>TA=0°C to +70°C | I <sub>IO</sub>      | —           | 0.5          | 200<br>2  | pA<br>nA |
| 输入偏置电流(VCM=0V, VO=0V)<br>TA=25°C<br>TA=0°C to +70°C | I <sub>IB</sub>      | —           | 3            | 200<br>10 | pA<br>nA |
| 输入共模电压范围<br>TA=25°C                                 | V <sub>ICR</sub>     | —<br>-11    | +14.5<br>-12 | +11<br>—  | V        |

|                                                              |                                                                          |                      |                      |                      |      |
|--------------------------------------------------------------|--------------------------------------------------------------------------|----------------------|----------------------|----------------------|------|
| 大信号电压增益 (RL=10KΩ, VO= ± 10 V0)<br>TA=25°C<br>TA=0°C to +70°C | A <sub>vol</sub>                                                         | 3.0<br>3.0           | 58<br>—              | —<br>—               | V/mV |
| 输出电压幅度 (RL=10KΩ, VID=10 V0)<br>TA=25°C<br>TA=0°C to +70°C    | V <sub>O+</sub><br>V <sub>O-</sub><br>V <sub>O+</sub><br>V <sub>O-</sub> | +10<br>—<br>+10<br>— | +14<br>-14<br>—<br>— | —<br>-10<br>—<br>-10 | V    |
| 共模抑制比<br>(RS=50Ω, VCM=VICR min, VO=0V, TA=25°C)              | CMR                                                                      | 70                   | 84                   | —                    | dB   |
| 共模抑制比<br>(RS=50Ω, VCM=0V, VO=0V, TA=25°C)                    | PSR                                                                      | 70                   | 86                   | —                    | dB   |
| 电源电流 (每个独立运放)<br>(空载, VO=0V, TA=25°C)                        | I <sub>D</sub>                                                           | —                    | 200                  | 250                  | uA   |
| 总功耗 (每个独立运放)<br>(空载, VO=0V, TA=25°C)                         | P <sub>D</sub>                                                           | —                    | 6.0                  | 7.5                  | mW   |

**交流电气特性** (VCC= + 15V, VEE= - 15V, TA= +25°C, 除非特殊说明)

| 参数                                                                   | 符号             | Min | Typ              | Max | 单位          |
|----------------------------------------------------------------------|----------------|-----|------------------|-----|-------------|
| 转换速率 (Vin= -10V to +10V, RL=10kΩ, CL=100pF, AV=+1.0)                 | SR             | 2.0 | 5.0              | —   | V/uS        |
| 上升时间 (Vin= 20mV, RL=10kΩ, CL=100pF, AV=+1.0)                         | Tr             | —   | 0.1              | —   | uS          |
| 偏离值 (Vin= 20mV, RL=10kΩ, CL=100pF, AV=+1.0)                          | OS             | —   | 10               | —   | %           |
| 建立时间<br>(VCC= +15V, VEE= -15V, AV=+1.0, RL=10kΩ, VO=0V to +10V step) | ts             | —   | 1.5<br>2.2       | —   | uS          |
| To within 10mV<br>To within 1.0mV                                    |                |     |                  |     |             |
| 增益带宽积 (f=200KHz)                                                     | GBW            | —   | 2.0              | —   | MHz         |
| 等效输入噪声 (RS=100Ω, f=1.0KHz)                                           | e <sub>n</sub> | —   | 47               | —   | nV/sqrt(Hz) |
| 输入电阻                                                                 | R <sub>i</sub> | —   | 10 <sup>12</sup> | —   | W           |
| 信道分离 (f=10KHz)                                                       | CS             | —   | 120              | —   | dB          |

Figure 1. Maximum Power Dissipation versus Temperature for Package Variations

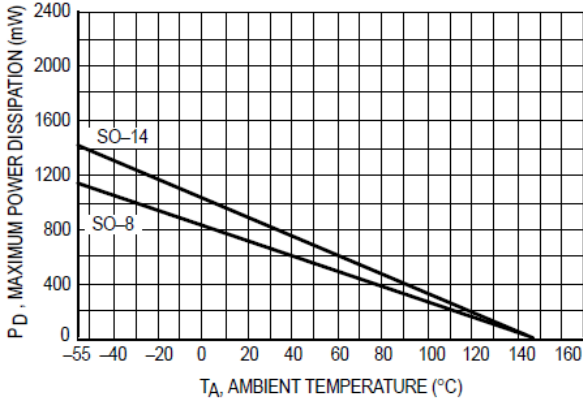


Figure 2. Output Voltage Swing versus Supply Voltage

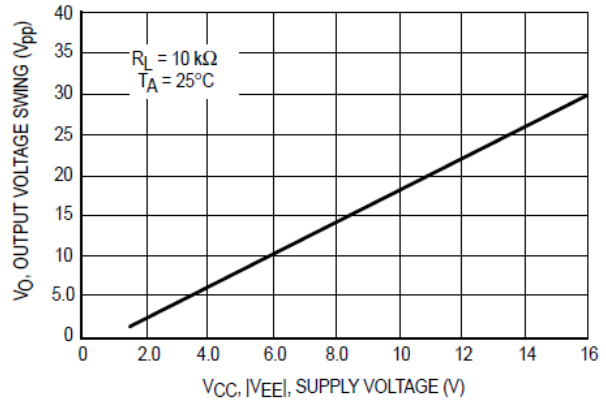


Figure 3. Output Voltage Swing versus Temperature

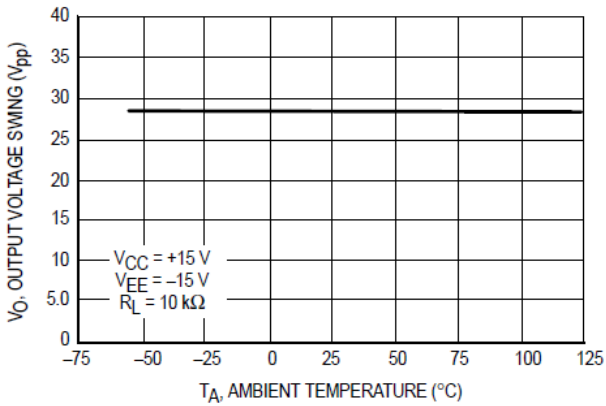


Figure 4. Output Voltage Swing versus Load Resistance

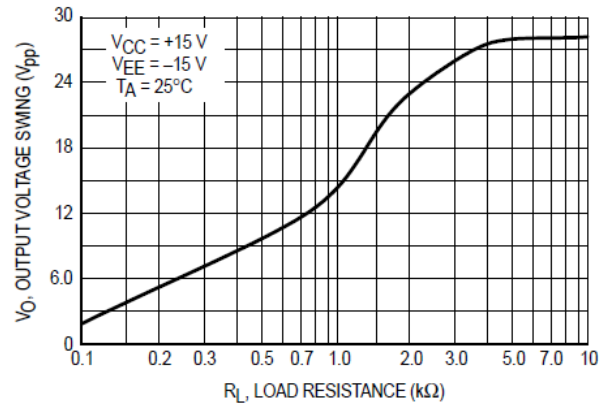


Figure 5. Output Voltage Swing versus Frequency

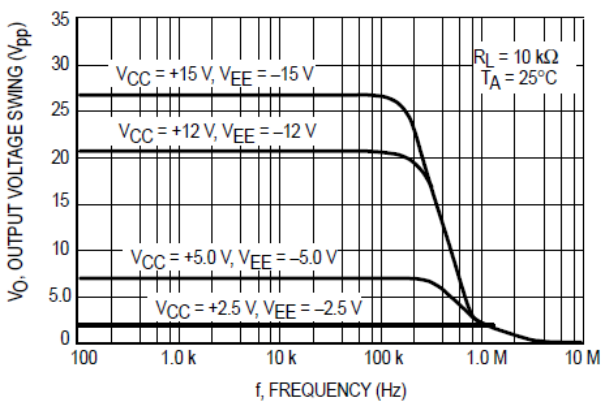
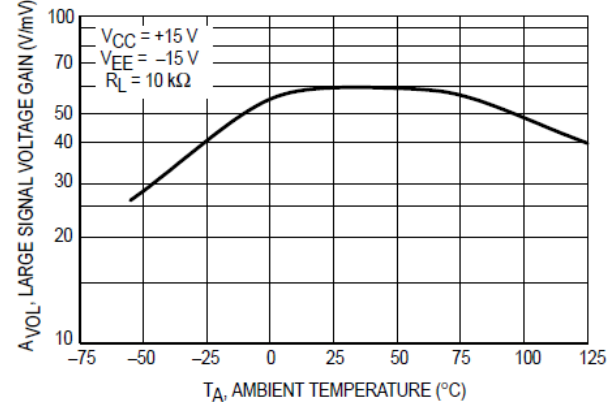
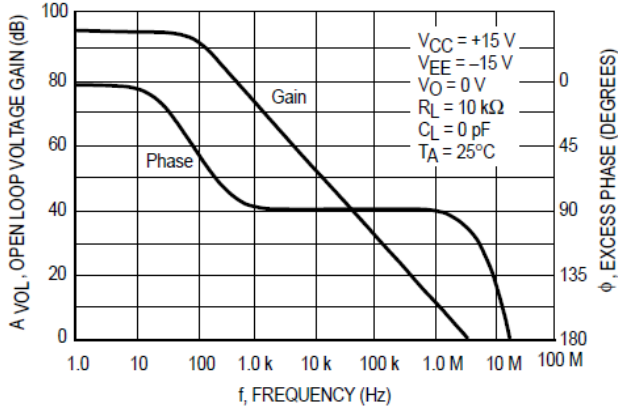


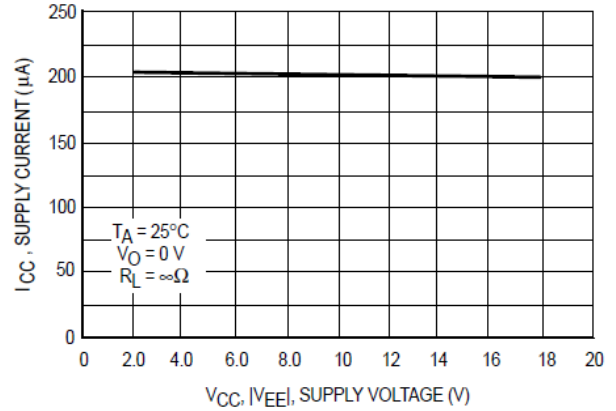
Figure 6. Large Signal Voltage Gain versus Temperature



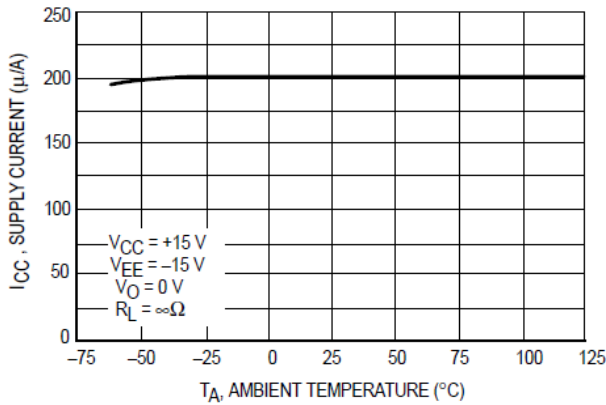
**Figure 7. Open Loop Voltage Gain and Phase versus Frequency**



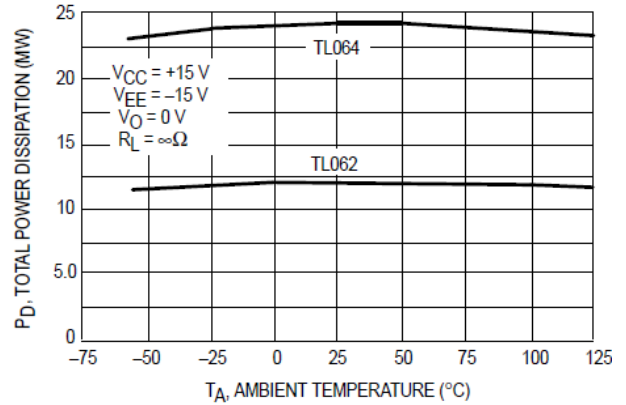
**Figure 8. Supply Current per Amplifier versus Supply Voltage**



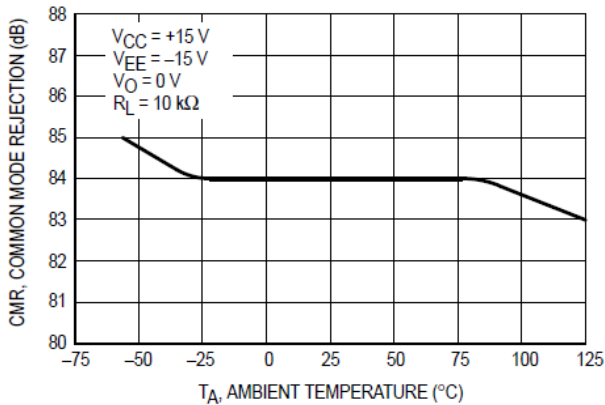
**Figure 9. Supply Current per Amplifier versus Temperature**



**Figure 10. Total Power Dissipation versus Temperature**



**Figure 11. Common Mode Rejection versus Temperature**



**Figure 12. Common Mode Rejection versus Frequency**

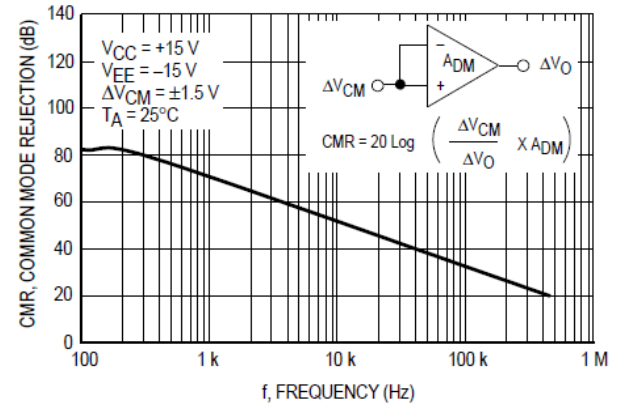


Figure 13. Power Supply Rejection versus Frequency

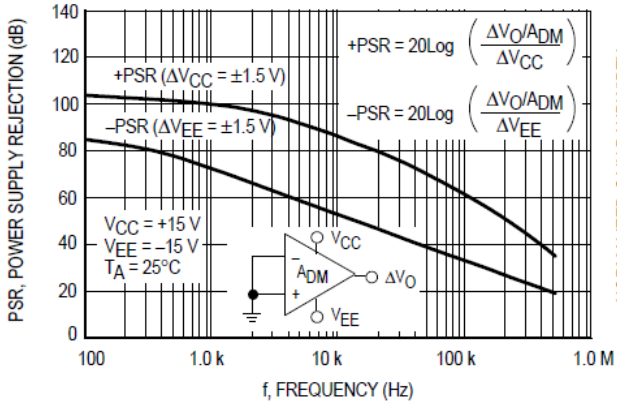


Figure 14. Normalized Gain Bandwidth Product, Slew Rate and Phase Margin versus Temperature

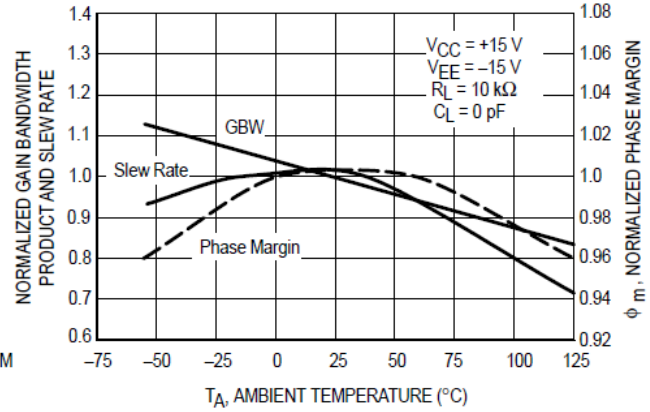


Figure 15. Input Bias Current versus Temperature

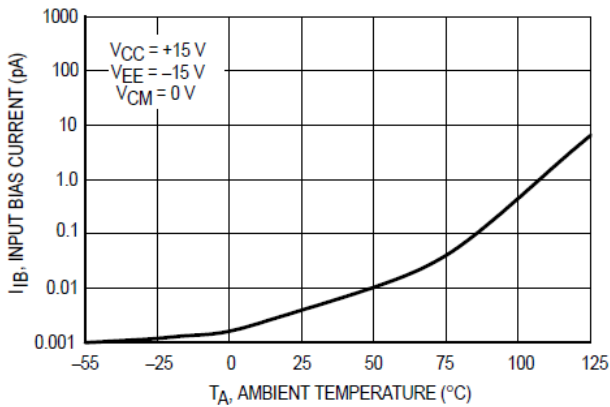


Figure 16. Input Noise Voltage versus Frequency

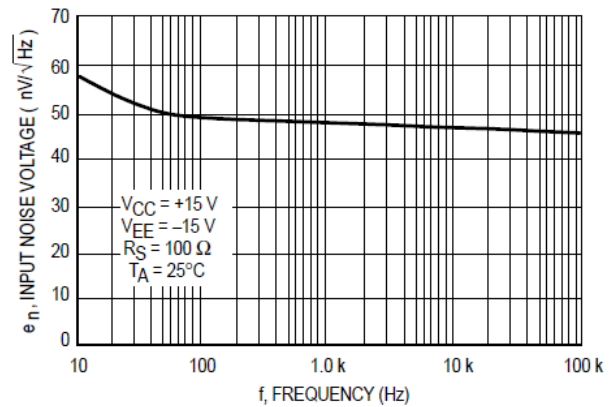


Figure 17. Small Signal Response

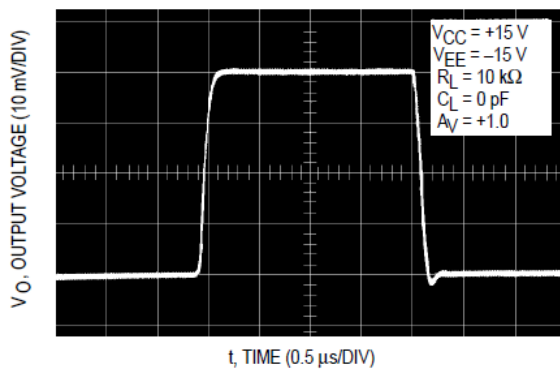
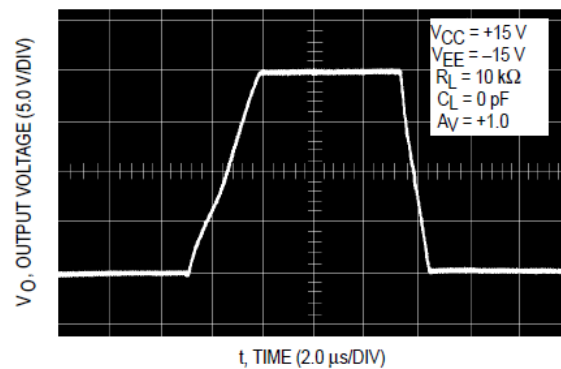
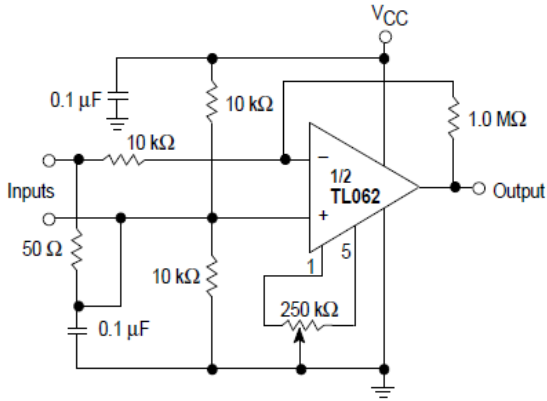


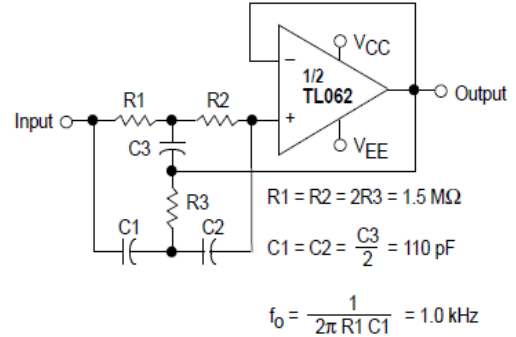
Figure 18. Large Signal Response



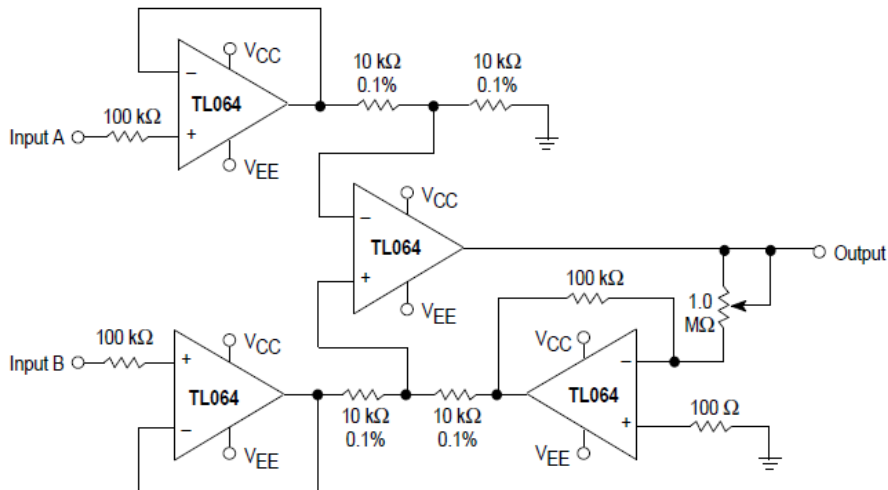
**Figure 19. AC Amplifier**



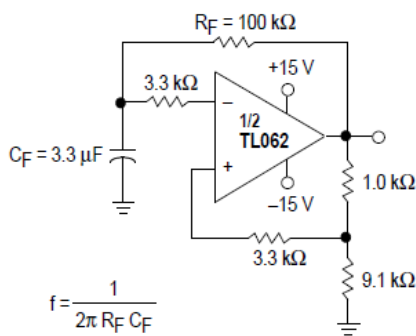
**Figure 20. High-Q Notch Filter**



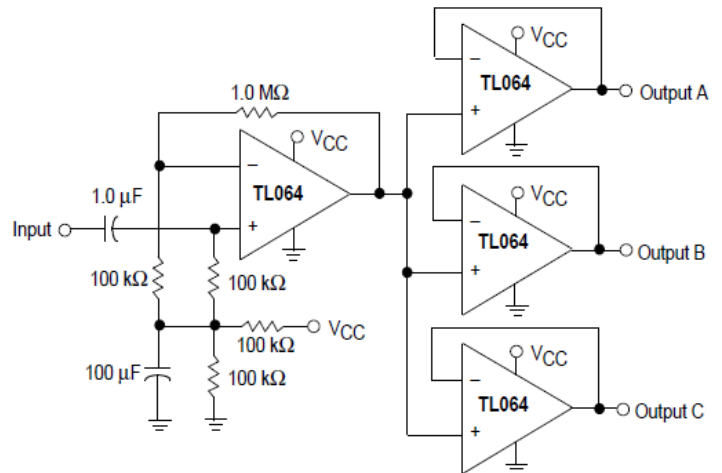
**Figure 21. Instrumentation Amplifier**



**Figure 22. 0.5 Hz Square-Wave Oscillator**



**Figure 23. Audio Distribution Amplifier**



封装外形

SOP8

| Dimensions In Millimeters |       |       |          |           |       |
|---------------------------|-------|-------|----------|-----------|-------|
| Symbol :                  | Min : | Max : | Symbol : | Min :     | Max : |
| A                         | 1.225 | 1.570 | D        | 0.400     | 0.950 |
| A1                        | 0.100 | 0.250 | Q        | 0°        | 8°    |
| B                         | 4.800 | 5.100 | a        | 0.420 TYP |       |
| C                         | 5.800 | 6.250 | b        | 1.270 TYP |       |
| C1                        | 3.800 | 4.000 |          |           |       |

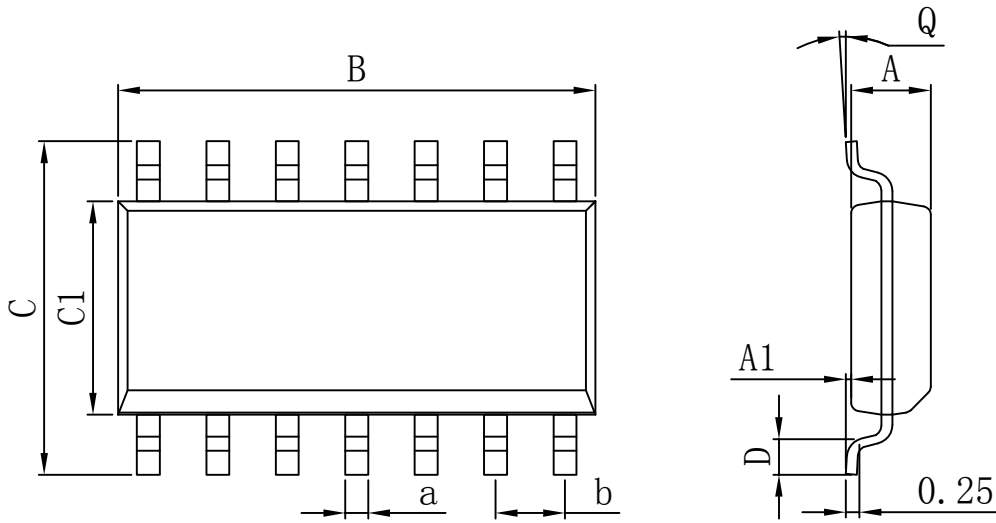
DIP8

| Dimensions In Millimeters |       |       |          |           |       |
|---------------------------|-------|-------|----------|-----------|-------|
| Symbol :                  | Min : | Max : | Symbol : | Min :     | Max : |
| A                         | 6.100 | 6.680 | L1       | 3.000     | 3.600 |
| B                         | 9.000 | 9.500 | a        | 1.524 TYP |       |
| D                         | 8.400 | 9.000 | b        | 0.889 TYP |       |
| D1                        | 7.420 | 7.820 | c        | 0.457 TYP |       |
| E                         | 3.100 | 3.550 | d        | 2.540 TYP |       |
| L                         | 0.500 | 0.700 |          |           |       |



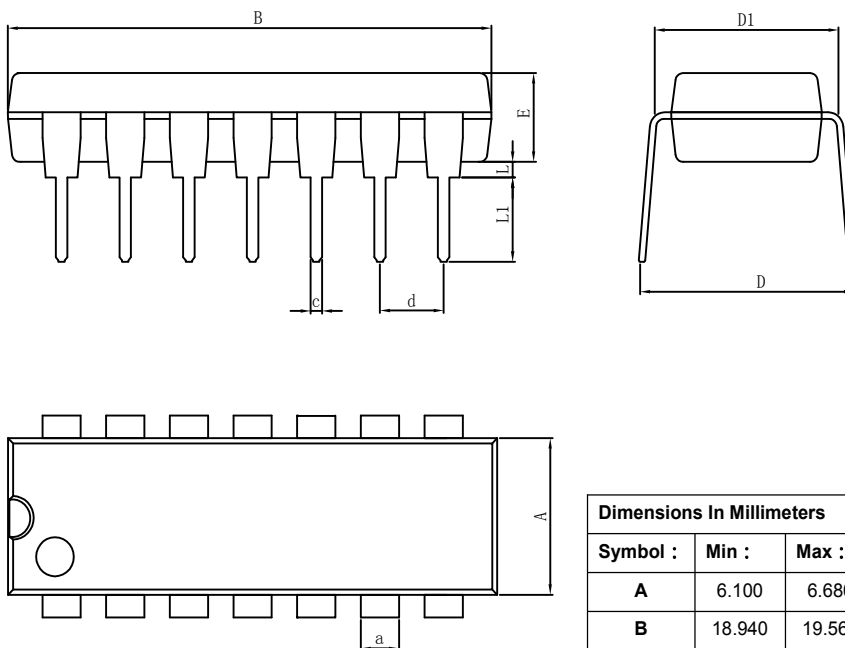
封装外形

SOP14



| Dimensions In Millimeters |       |       |          |           |       |
|---------------------------|-------|-------|----------|-----------|-------|
| Symbol :                  | Min : | Max : | Symbol : | Min :     | Max : |
| A                         | 1.225 | 1.570 | D        | 0.400     | 0.950 |
| A1                        | 0.100 | 0.250 | Q        | 0°        | 8°    |
| B                         | 8.500 | 9.000 | a        | 0.420 TYP |       |
| C                         | 5.800 | 6.250 | b        | 1.270 TYP |       |
| C1                        | 3.800 | 4.000 |          |           |       |

DIP14



| Dimensions In Millimeters |        |        |          |           |       |
|---------------------------|--------|--------|----------|-----------|-------|
| Symbol :                  | Min :  | Max :  | Symbol : | Min :     | Max : |
| A                         | 6.100  | 6.680  | L        | 0.500     | 0.800 |
| B                         | 18.940 | 19.560 | L1       | 3.000     | 3.600 |
| D                         | 8.200  | 9.200  | a        | 1.524 TYP |       |
| D1                        | 7.42   | 7.820  | c        | 0.457 TYP |       |
| E                         | 3.100  | 3.550  | d        | 2.540 TYP |       |

**重要声明：**

华冠半导体保留未经通知更改所提供的产品和服务。客户在订货前应获取最新的相关信息，并核实这些信息是否最新且完整的。

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